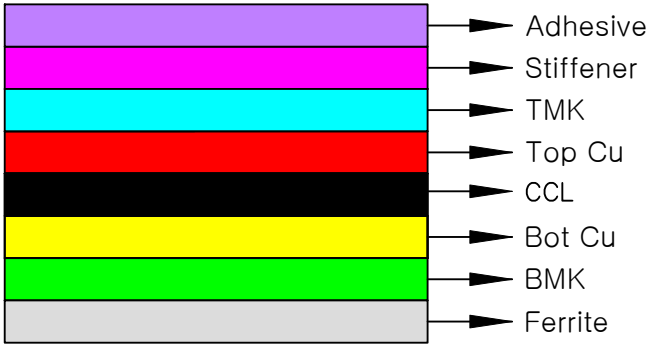


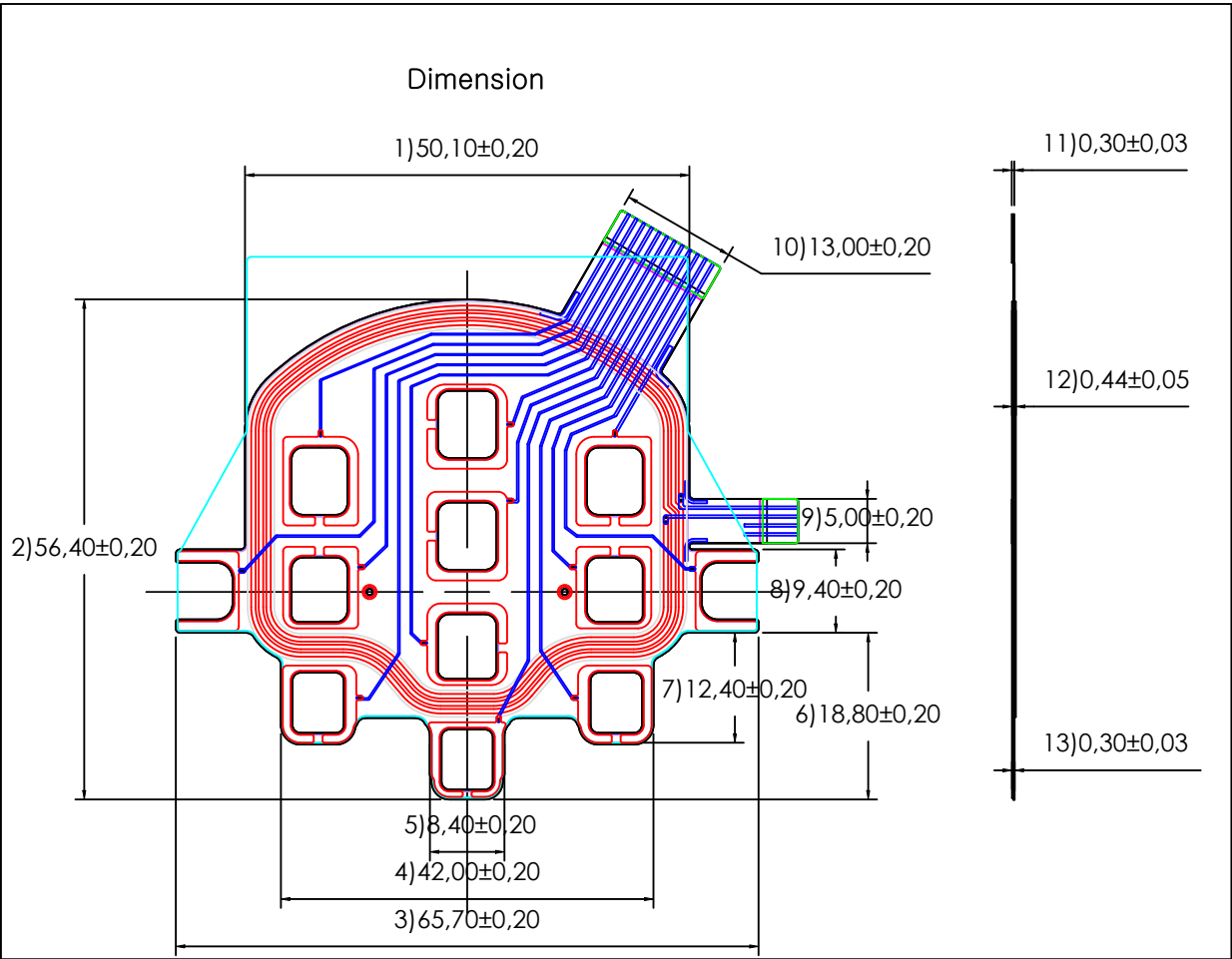
- STACKING INFORMATION



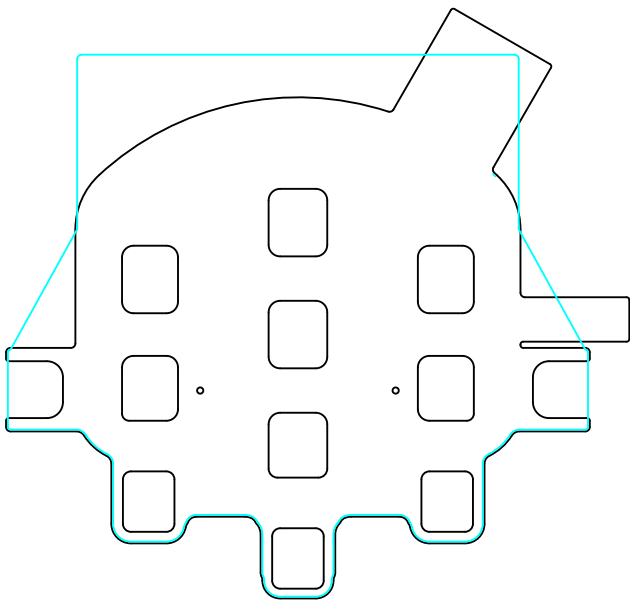
- MATERIAL INFORMATION

ITEM	SPEC.
1 Adhesive	150um
2 Stiffener	kaption 5mil + Bonding 50um => 175um
3 Silk	10um
4 TMK	Coverlay 1/2mil (yellow), Bonding 15um => 27.5um
5 CCL	Base Polyimide (1/2mil, Ad=12um, 3Layer), Cu (1/2oz), Double-sided(E2D) => 72.5um
6 BMK	Coverlay 1/2mil (yellow), Bonding 15um => 27.5um
7 Ferrite	140um
8	
9 Cu Plating	10um
Plating Part	NI/Au

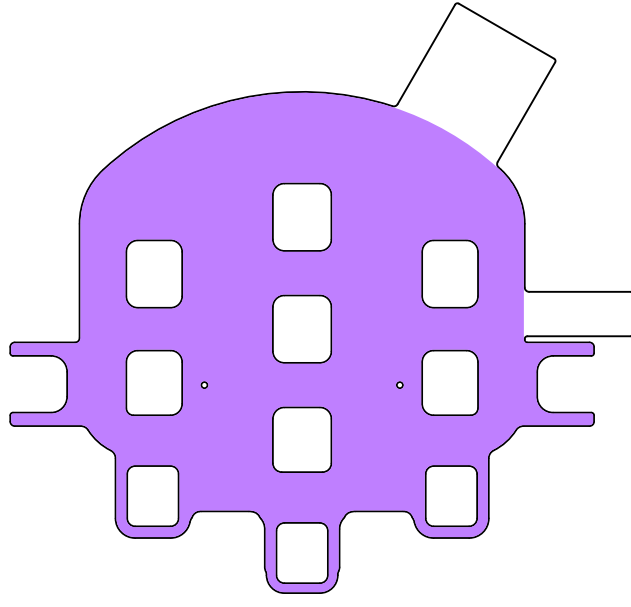
※ All material is Halogen-free and not included Pb, Cd, Hg, Cr+6
※ 3LAYER



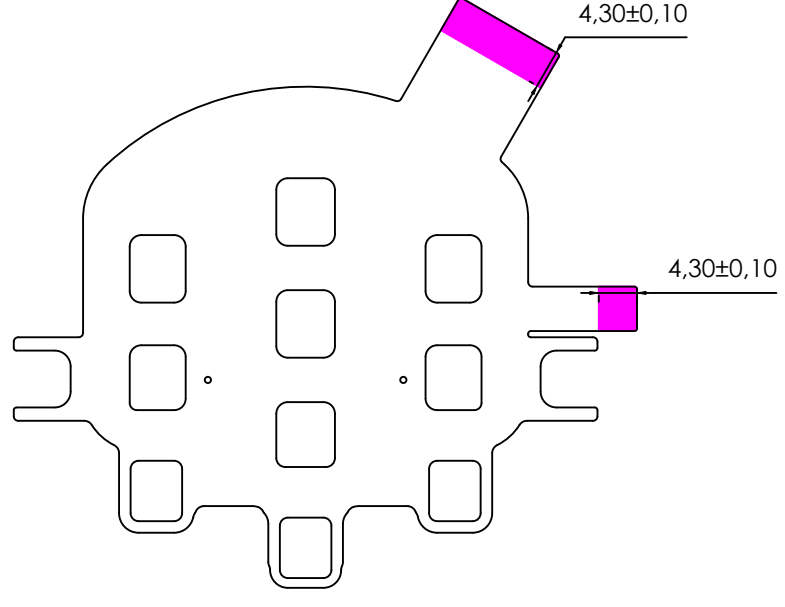
Release paper



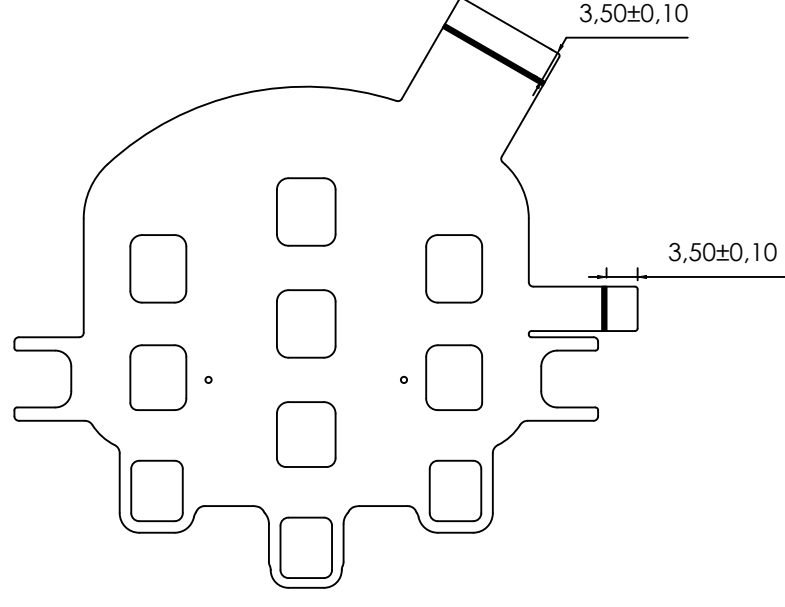
Adhesive



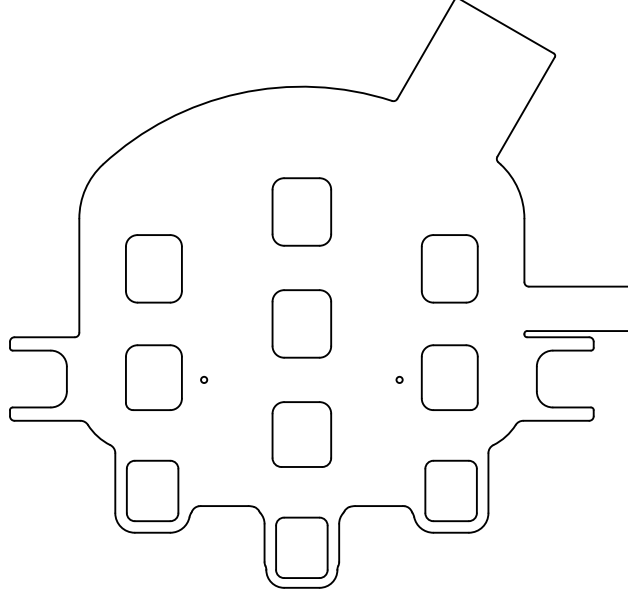
Stiffener



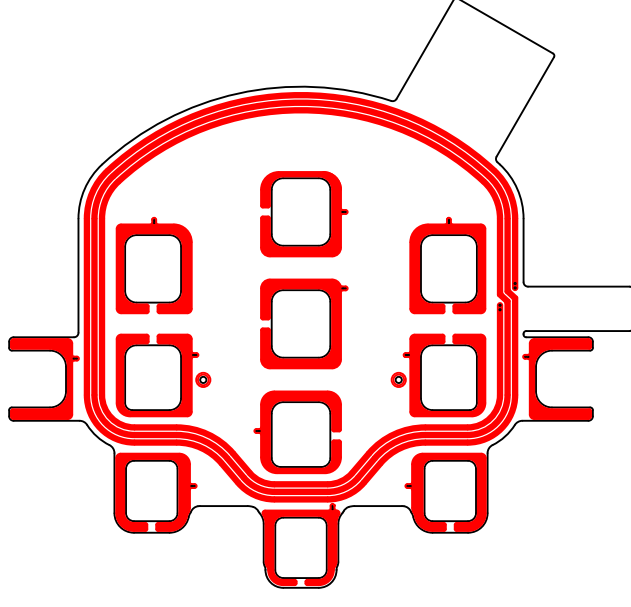
Silk



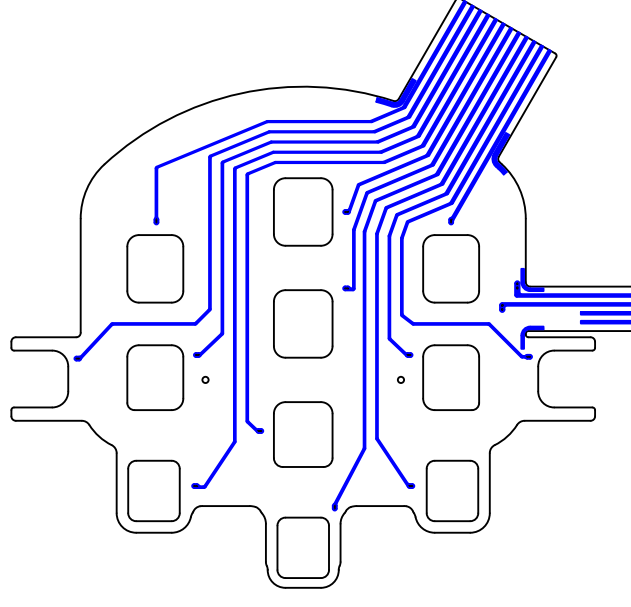
TMK



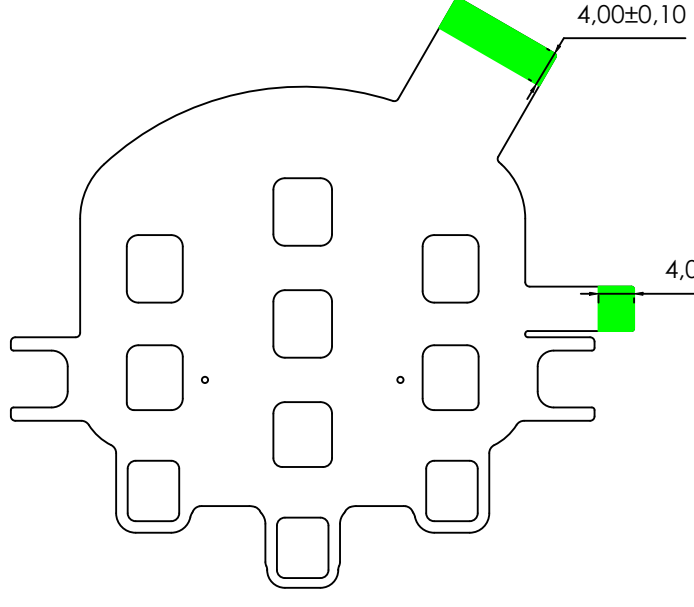
TOP



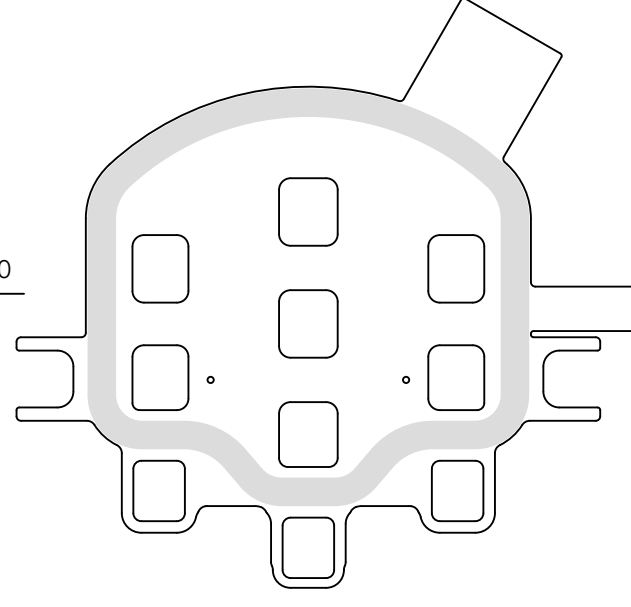
BOT



BMK



Ferrite



Representing of layer dimensions method ISO 17081	
Dimension	Tolerance
0.5 - 5	±0.05
5 - 6	±0.05
6 - 25	±0.1
25 - 100	±0.15
100 - 400	±0.2
400 - 1000	±0.3
1000 - 2000	±0.5

※ Drawing dimension unit is millimeter.
※ Unit is indicated except for the reason listed below.

Drawing No.	Draw Date_Pack-017_20260305	Scale	1:1	Designed		Checked		Approved	
Application		Unit	mm						
Protection	3rd ANGLE	Sheet NO.	1/1	Chilho Lee					
Material		DWG size	A3	2026.03.05					
Description									

NO.	DATE	Revision history
1	2025.09.02	신규 Drawing
2	2025.11.04	디자인 변경
	2025.11.09	SWK추가
3	2025.01.28	Inner Tag圖면 제거
4	2026.03.05	타치홀드 디자인 변경